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## (54) RESIN MOLDING AND LIGHT REFLECTOR

## (57)Abstract:

**PROBLEM TO BE SOLVED:** To provide a resin molding having excellent heat resistance, productivity, fracture resistance and light reflecting performance and a light reflector contributing to a reduction of a power consumption when used for an electric decoration signboard or the like.

**SOLUTION:** The resin molding comprises a multilayer structure including a mixed resin layer containing an aromatic polycarbonate resin (A) of 35 to 75 wt.%, a thermoplastic resin or/and a thermoplastic elastomer (B) of 5 to 45 wt.% except the aromatic polycarbonate resin, and a flame retardant (C) of 0 to 35 wt.% and a white pigment (D) of 0 to 15 wt.% (wherein (A)+(B)+(C)+(D)=100 wt.%). A rear layer containing a synthetic resin or a synthetic resin composition having an Izod impact value of at least 5 kJ/m<sup>2</sup> and is integrally adhered to the rear surface of the mixed resin layer, in such a manner that a total reflectivity of a parameter for representing a reflection of a light on the surface of the mixed resin layer is 80% or more and a diffusion reflectivity is 75% or more. The light reflector is provided as a product of the resin.

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